

Pages 1 to 17

# TRANSISTORS, MATCHED DUAL, NPN

BASED ON TYPE 2N2919, 2N2920 and 2N2920A

ESCC Detail Specification No. 5207/002

Issue 3 September 2009



PAGE 2

ISSUE 3

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PAGE 3

ISSUE 3

### **DOCUMENTATION CHANGE NOTICE**

(Refer to https://escies.org for ESCC DCR content)

| DCR No.  | CHANGE DESCRIPTION   | 11 - |
|----------|--|------|
| 447, 506 | Specification up issued to incorporate editorial and technical changes per DCRs. |      |



PAGE 4

ISSUE 3

## TABLE OF CONTENTS

| <u>1.</u>   | GENERAL  | <u>5</u> |
|-------------|--|----------|
| 1.1         | Scope  | - 5      |
| 1.2         | Applicable Documents                                       | 5        |
| 1.3         | Terms, Definitions, Abbreviations, Symbols and Units       | 5        |
| 1.4         | The ESCC Component Number and Component Type Variants      | 5        |
| 1.4.1       | The ESCC Component Number                                  | 5        |
| 1.4.2       | Component Type Variants                                    | 5        |
| 1.5         | Maximum Ratings  | 6        |
| 1.6         | Physical Dimensions and Terminal Identification            | 7        |
| 1.6.1       | Metal Can Package (TO-77) - 6 lead                         |          |
| 1.6.2       | Chip Carrier Package (CCP) - 6 terminal                    | 8        |
| 1.7         | Functional Diagram   | 9        |
| 1.8         | Materials and Finishes                                     | 9        |
| 2.          | REQUIREMENTS   | 10       |
| 2.1         | General  | 10       |
| 2.1.1       | Deviations from the Generic Specification                  | 10       |
| 2.2         | Marking  | 10       |
| 2.3         | Terminal Strength  | 10       |
| 2.4         | Electrical Measurements at Room, High and Low Temperatures | 10       |
| 2.4.1       | Room Temperature Electrical Measurements                   | 10       |
| 2.4.2       | High and Low Temperatures Electrical Measurements          | . 13     |
| 2.5         | Parameter Drift Values                                     | 14       |
| 2.6         | Intermediate and End-Point Electrical Measurements         | 15       |
| 2.7         | Power Burn-in Conditions                                   | 16       |
| 2.8         | Operating Life Conditions                                  | 16       |
| APPENDIX 'A |  | 17       |



#### 1. GENERAL

#### 1.1 SCOPE

This specification details the ratings, physical and electrical characteristics and test and inspection data for the component type variants and/or the range of components specified below. It supplements the requirements of, and shall be read in conjunction with, the ESCC Generic Specification listed under Applicable Documents.

### 1.2 APPLICABLE DOCUMENTS

The following documents form part of this specification and shall be read in conjunction with it:

- (a) ESCC Generic Specification No. 5000
- (b) MIL-STD-750, Test Methods and Procedures for Semiconductor Devices

# 1.3 TERMS, DEFINITIONS, ABBREVIATIONS, SYMBOLS AND UNITS

For the purpose of this specification, the terms, definitions, abbreviations, symbols and units specified in ESCC Basic Specification No. 21300 shall apply.

## 1.4 THE ESCC COMPONENT NUMBER AND COMPONENT TYPE VARIANTS

### 1.4.1 The ESCC Component Number

The ESCC Component Number shall be constituted as follows:

Example: 520700202

- Detail Specification Reference: 5207002
- Component Type Variant Number: 02 (as required)

### 1.4.2 Component Type Variants

The component type variants applicable to this specification are as follows:

| Variant<br>Number | Based on Type | Case  | Lead/Terminal Material and/or Finish | Weight<br>max g |
|-------------------|---------------|-------|--------------------------------------|-----------------|
| 02                | 2N2920        | TO-77 | D2                                   | 1               |
| 03                | 2N2920A       | TO-77 | D2                                   | 1               |
| 04                | 2N2919        | TO-77 | D3 or D4                             | 1               |
| 05                | 2N2920        | TO-77 | D3 or D4                             | 1               |
| 06                | 2N2920A       | TO-77 | D3 or D4                             | 1               |
| 07                | 2N2919        | TO-77 | D7                                   | 1               |
| 08                | 2N2920        | TO-77 | D7                                   | 1               |
| 09                | 2N2920A       | TO-77 | D7                                   | 1               |
| 10                | 2N2919        | CCP   | 2                                    | 0.2             |

| i | 6 | 2 N2320A  | FP-8 | 62  | 0,7 |
|---|---|-----------|------|-----|-----|
| 1 | 7 | 2 N2 320A | FP-8 | 6 4 | 0,7 |



| Variant<br>Number | Based on Type | Case | Lead/Terminal Material and/or Finish | Weight max g |
|-------------------|---------------|------|--------------------------------------|--------------|
| 11                | 2N2920        | CCP  | 2                                    | 0.2          |
| 12                | 2N2920A       | CCP  | 2                                    | 0.2          |
| 13                | 2N2919        | CCP  | 4                                    | 0.2          |
| 14                | 2N2920        | CCP  | 4                                    | 0.2          |
| 15                | 2N2920A       | CCP  | 4                                    | 0.2          |

The lead/terminal material and/or finish shall be in accordance with the requirements of ESCC Basic Specification No. 23500.

#### 1.5 <u>MAXIMUM RATINGS</u>

The maximum ratings shall not be exceeded at any time during use or storage.

Maximum ratings shall only be exceeded during testing to the extent specified in this specification and when stipulated in Test Methods and Procedures of the ESCC Generic Specification.

| Characteristics                               | Symbols              | Maximum Ratings | Unit | Remarks  |
|---|----------------------|-----------------|------|--|
| Collector-Base Voltage                        | V <sub>CBO</sub>     | 60              | V    | Over entire                                    |
| Collector-Emitter Voltage                     | V <sub>CEO</sub>     | 60              | V    | operating temperature                          |
| Emitter-Base Voltage                          | V <sub>EBO</sub>     | 6               | V    | range  |
| Collector Current                             | lc                   | 30              | mA   | Continuous                                     |
| Power Dissipation (One Section)               |                      |                 |      |  |
| For TO-77 and CCP and FP-8                    | P <sub>totO1</sub>   | 0.3             | W    | At T <sub>amb</sub> ≤ +25°C                    |
| For TO-77                                     | P <sub>totO2</sub>   | 0.75            | W    | At T <sub>case</sub> ≤ +25°C                   |
| Power Dissipation (Both Sections)             |                      |                 |      |  |
| For TO-77 and CCP and FP.8                    | P <sub>totB1</sub>   | 0.5             | W    | At $T_{amb} \le +25^{\circ}C$                  |
| For TO-77                                     | P <sub>totB2</sub>   | 1.25            | W    | At T <sub>case</sub> ≤ +25°C                   |
| Thermal Resistance,<br>Junction-to-Ambient    | R <sub>th(j-a)</sub> | 583.3<br>350    | °C/W | For one section<br>For both sections           |
| Thermal Resistance,<br>Junction-to-Case       | R <sub>th(j-c)</sub> | 233.3<br>140    | °C/W | For one section<br>For both sections<br>Note 1 |
| Operating Temperature Range                   | T <sub>op</sub>      | -55 to +200     | °C   | Note 2   |
| Storage Temperature Range                     | T <sub>stg</sub>     | -65 to +200     | °C   | Note 2   |
| Soldering Temperature<br>For TO-77<br>For CCP | T <sub>sol</sub>     | +260<br>+245    | °C   | Note 3<br>Note 4                               |

| Soldering Temperature<br>FOR FP-8 | TSOL | +265 | OC | Nole3 |
|-----------------------------------|------|------|----|-------|
|-----------------------------------|------|------|----|-------|



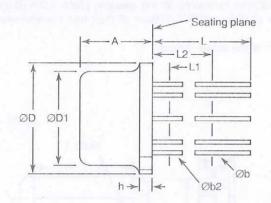
ISSUE 3

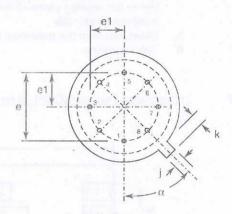
#### NOTES:

- Thermal Resistance, Junction-to-Case only applies to TO-77 packaged Variants.
- For Variants with tin-lead plating or hot solder dip lead finish all testing, and any handling, performed at T<sub>amb</sub> > +125°C shall be carried out in a 100% inert atmosphere.
- Duration 10 seconds maximum at a distance of not less than 1.5mm from the device body and the same lead shall not be resoldered until 3 minutes have elapsed.
- Duration 5 seconds maximum and the same terminal shall not be resoldered until 3 minutes have

#### 1.6 PHYSICAL DIMENSIONS AND TERMINAL IDENTIFICATION

#### 1.6.1 Metal Can Package (TO-77) - 6 lead





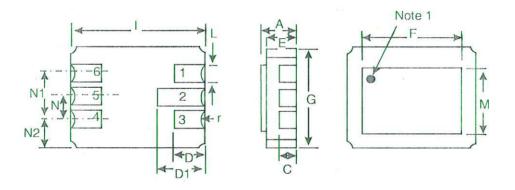
| Symbols | Dimensi | ons mm | Notes |
|---------|---------|--------|-------|
| Symbols | Min     | Max    | Notes |
| А       | 6.1     | 6.6    |       |
| Øb      | 0.406   | 0.533  | 2, 3  |
| Øb2     | 0.406   | 0.483  | 2, 3  |
| ØD      | 8.51    | 9.4    |       |
| ØD1     | 7.75    | 8.51   |       |
| е       | 5.08    | BSC    | 4     |
| e1      | 2.54    | BSC    | 4     |
| h       |         | 1.02   |       |
| j       | 0.711   | 0.864  |       |
| k       | 0.737   | 1.14   | 5     |
| L       | 12.7    | -      | 2     |
| L1      |         | 1.27   | 3     |
| L2      | 6.35    |        | 3     |



| Cymbola | Dimensi | Notos |         |
|---------|---------|-------|---------|
| Symbols | Min     | Max   | Notes   |
| C/.     | 45° BSC |       | 1. 4, 6 |

- Terminal identification is specified by reference to the tab position where lead 1 = collector 1, lead 2 = base 1, lead 3 = emitter 1, lead 5 = emitter 2, lead 6 = base 2 and lead 7 = collector 2. Lead numbers 4 and 8 are not present on the actual package; they are shown in the drawing for information only.
- 2. Applies to all leads.
- 3. Øb2 applies between L1 and L2. Øb applies between L2 and 12.7mm from the seating plane. Diameter is uncontrolled within L1 and beyond 12.7mm from the seating plane.
- 4. Leads having maximum diameter 0.483mm measured in the gauging plane 1.37(+0.025,-0)mm below the seating plane of the device shall be within 0.178mm of their true position relative to a maximum-width-tab.
- 5. Measured from the maximum diameter of the actual device.
- 6. Tab centreline.

#### 1.6.2 Chip Carrier Package (CCP) - 6 terminal



| Cumbala | Dimensi | Notes |       |
|---------|---------|-------|-------|
| Symbols | Min     | Max   | Notes |
| А       | 1.53    | 1.96  |       |
| С       | 0.89 TY | PICAL | 2     |
| D       | 1.52    | 1.78  |       |
| D1 -    | 2.08    | 2.49  |       |
| Е       | 1.24    | 1.55  |       |
| F       | 5.76    | 5.92  |       |
| G       | 4.19    | 4.45  |       |
| L       | 6.1     | 6.35  |       |
| L       | 0.55    | 0.71  | 2     |

1.6.3.

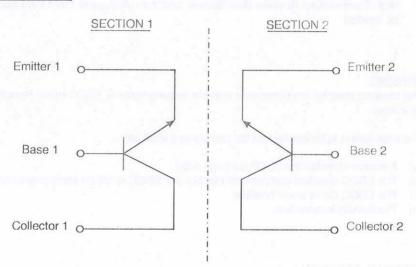




| Symbols     | Dimensi | Notes  |        |
|-------------|---------|--------|--------|
| Cymbols     | Min     | Max    | ivoles |
| М           | 3.86    | 4.01   |        |
| N           | 1.14    | 1.4    |        |
| N1          | 2.41    | 2.67   |        |
| N2          | 0.89 T\ | /PICAL |        |
| ot reducing | 0.23 TY | /PICAL | 2      |

- 1. Terminal identification is specified, when viewing the top side of the package, by reference to a black ink dot adjacent to terminal 1 = base 2. Terminal 2 = collector 2, terminal 3 = emitter 2, terminal 4 = emitter 1, terminal 5 = collector 1 and terminal 6 = base 1.
- 2. Applies to all terminals.

#### 1.7 <u>FUNCTIONAL DIAGRAM</u>



#### NOTES:

- 1. For TO-77, the case is not connected to any lead.
- 2. For CCP, the lid is not connected to any terminal.
- 3 For F.8 The lid is connected to 4 and 5 terminal.

### 1.8 <u>MATERIALS AND FINISHES</u>

Materials and finishes shall be as follows:

- a) Case
  - For the metal can package the case shall be hermetically sealed and have a metal body with hard glass seals.
  - For the chip carrier package the case shall be hermetically sealed and have a ceramic body with a Kovar lid.
- b) Leads/Terminals



ISSUE 3

As specified in Component Type Variants.

#### 2. REQUIREMENTS

#### 2.1 GENERAL

The complete requirements for procurement of the components specified herein are as stated in this specification and the ESCC Generic Specification. Permitted deviations from the Generic Specification, applicable to this specification only, are listed below.

Permitted deviations from the Generic Specification and this Detail Specification, formally agreed with specific Manufacturers on the basis that the alternative requirements are equivalent to the ESCC requirement and do not affect the component's reliability, are listed in the appendices attached to this specification.

#### 2.1.1 <u>Deviations from the Generic Specification</u>

(a) Deviation from Screening Tests - Chart F3
 High Temperature Reverse Bias Burn-in and the subsequent Final Measurements for HTRB shall be omitted.

#### 2.2 MARKING

The marking shall be in accordance with the requirements of ESCC Basic Specification No. 21700 and as follows.

The information to be marked on the component shall be:

- (a) Terminal identification (CCP package only).
- (b) The ESCC qualified components symbol (for ESCC qualified components only).
- (c) The ESCC Component Number.
- (d) Traceability information.

#### 2.3 TERMINAL STRENGTH

The test conditions for terminal strength, tested as specified in the ESCC Generic Specification, shall be as follows:

For TO-77, Test Condition: E, lead faligue. For FF-8. Test concliction E, lead falique. 3 ounce Weight, 3 bonds of 15-lyn

- 2.4 <u>ELECTRICAL MEASUREMENTS AT ROOM, HIGH AND LOW TEMPERATURES</u> Electrical measurements shall be performed at room, high and low temperatures.
- 2.4.1 Room Temperature Electrical Measurements

The measurements shall be performed at Tamb=+22 ±3°C.



| Characteristics                           | Symbols              | MIL-STD-750 | Test Conditions  | Lin     | nits | Units |
|---|----------------------|-------------|--|---------|------|-------|
|   | Was in the           | Test Method |  | Min     | Max  |       |
| Collector-Base<br>Breakdown<br>Voltage    | V <sub>(BR)CBO</sub> | 3001        | I <sub>C</sub> = 10μA, Bias<br>condition D                                 | 60      | -    | V     |
| Collector-Emitter<br>Breakdown<br>Voltage | V <sub>(BR)CEO</sub> | 3011        | I <sub>C</sub> = 10mA, Bias<br>condition D,<br>Note 1                      | 60      |      | V     |
| Emitter-Base<br>Breakdown<br>Voltage      | V <sub>(BR)EBO</sub> | 3026        | $I_E = 10\mu A$ , Bias condition D   | 6       |      | V     |
| Collector-Emitter<br>Cut-off Current      | I <sub>CEO</sub>     | 3041        | V <sub>CE</sub> = 5V, Bias condition D                                     | -       | 2    | nA    |
| Collector-Base<br>Cut-off Current         | ГСВО                 | 3036        | V <sub>CB</sub> = 45V, Bias condition D                                    | Chrylin | 2    | nA    |
| Collector-Base<br>Cut-off Current         | I <sub>EBO</sub>     | 3061        | V <sub>EB</sub> = 5V, Bias condition D                                     | -       | 2    | nA    |
| Collector-Emitter<br>Saturation Voltage   | V <sub>CE(sat)</sub> | 3071        | I <sub>C</sub> =1mA<br>I <sub>B</sub> =0.1mA<br>Note 1                     | - 1993  | 350  | mV    |
| Base-Emitter<br>Saturation Voltage        | V <sub>BE(sat)</sub> | 3066        | I <sub>C</sub> =1mA<br>I <sub>B</sub> =0.1mA<br>Test Condition A<br>Note 1 | 0.5     | 1    | V     |





ISSUE 3

| Characteristics                                 | Symbols MIL-STD-750                        |             | Test Conditions  | Lin           | Units      |     |
|---|--|-------------|--|---------------|------------|-----|
|   |  | Test Method |  | Min           | Max        |     |
| Forward-Current<br>Transfer Ratio               | h <sub>FE1</sub>                           | 3076        | V <sub>CE</sub> =5V; I <sub>C</sub> = 10μA<br>Variants 04, 07, 10, 13<br>Variants 02, 03, 05, 06,<br>08, 09, 11, 12, 14, 15  | 60<br>150     | 240<br>600 | -   |
|   | h <sub>FE2</sub>                           | 3076        | V <sub>CE</sub> =5V; I <sub>C</sub> = 100μA<br>Variants 04, 07, 10, 13<br>Variants 02, 03, 05, 06,<br>08, 09, 11, 12, 14, 15   | 100<br>225    | -          | -   |
|   | h <sub>FE3</sub>                           | 3076        | V <sub>CE</sub> =5V; I <sub>C</sub> = 1mA<br>Variants 04, 07, 10, 13<br>Variants 02, 03, 05, 06, 08, 09, 11, 12, 14, 15  | 150<br>300    | 2          | =:  |
| Forward-Current<br>Transfer Ratio<br>Comparison | h <sub>FE2-1</sub> /<br>h <sub>FE2-2</sub> | 3076        | $V_{CE}=5V ; I_{C}=100\mu A$   | 0.9           | 1          | -   |
| Base-Emitter<br>Voltage<br>Differential         | IV <sub>BE1</sub> -<br>V <sub>BE2</sub> I1 | 3066        | $\begin{array}{c} V_{CE} = 5V : I_{C} = 10 \mu A \\ Test \ Condition \ B \\ Variants \ 02, \ 04, \ 05, \ 07, \\ 08. \ 10, \ 11, \ 13, \ 14 \\ Variants \ 03, \ 06, \ 09, \ 12, \\ 15 \\ Note \ 2 \end{array}$                    | * [ .         | 5          | mV  |
|   | IV <sub>BE1</sub> -<br>V <sub>BE2</sub> I2 | 3066        | $\begin{array}{c} V_{CE}{=}5V~;~I_{C}=100\mu A\\ Test~Condition~B\\ Variants~02,~04,~05,~07,\\ 08,~10,~11,~13,~14\\ Variants~03,~06,~09,~12,\\ 15\\ Note~2 \end{array}$  | -             | 3          | mV  |
|   | IV <sub>BE1</sub> -<br>V <sub>BE2</sub> I3 | 3066        | $\begin{array}{c} V_{CE} = 5V \; ; \; I_{C} = 1 \text{mA} \\ \text{Test Condition B} \\ \text{Variants 02, 04, 05, 07,} \\ 08, \; 10, \; 11, \; 13, \; 14 \\ \text{Variants 03, 06, 09, 12,} \\ 15 \\ \text{Note 2} \end{array}$ | 1 <del></del> | 5 2        | mV  |
| Leakage Current<br>Between Sections             | I <sub>LS(e-e)</sub>                       | -           | 50V to Emitter 2<br>0V to Emitter 1  | -             | 5          | μА  |
|   | I <sub>LS(b-b)</sub>                       | ÷ .         | 50V to Base 2<br>0V to Base 1  | . 9           | 5          | μА  |
|   | I <sub>LS(c-c)</sub>                       | -           | 50V to Collector 2<br>0V to Collector 1  | 5             | 5          | μΑ  |
| Current Gain<br>Bandwidth<br>Product            | f <sub>T</sub>                             | 3206        | V <sub>CE</sub> =5V,<br>I <sub>C</sub> =500μA<br>f=20MHz<br>Note 3   | 60            | *          | MHz |



| Characteristics                      |                  | MIL-STD-750 |   | Limits   |     | Units |
|--------------------------------------|------------------|-------------|---|--|-----|-------|
|                                      |                  | Test Method |   | Min  | Max |       |
| Small-Signal<br>Output<br>Admittance | h <sub>oe</sub>  | 3216        | V <sub>CE</sub> =5V,<br>I <sub>C</sub> =1mA<br>i=1kHz<br>Note 3   | MACHAN   | 1   | μmho  |
| Spot Noise Figure                    | NF <sub>s</sub>  | 3246        | $V_{CE}=5V$ $I_{C}=10\mu A$ $R_{S}=10k\Omega$ $f=1kHz$ $BW=200Hz$ Note 3  | Approximately and a second sec | 3   | dB    |
| Wide-Band Noise<br>Figure            | NF <sub>w</sub>  | 3246        | $V_{CE}$ =5 $V$<br>$I_{C}$ =10 $\mu$ A<br>$R_{s}$ =10 $k\Omega$<br>10Hz≤f<15.7 $k$ Hz<br>BW=10 $k$ Hz<br>Note 3 |  | 3   | dB    |
| Output<br>Capacitance                | C <sub>obo</sub> | 3236        | $V_{CB}=5V$ ,<br>$I_{E}=0A$<br>$100kHz \le f \le 1MHz$<br>Note 3  |  | 6   | pF    |
| Small-Signal Input<br>Impedance      | h <sub>ib</sub>  | 3201        | V <sub>CB</sub> =5V,<br>I <sub>C</sub> =1mA<br>f=1kHz<br>Note 3   | 25   | 32  | Ω     |

- 1. Pulsed measurement: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 2. Any device whose measurement values exceed the specified limits shall be removed from the lot, but only count for PDA when such values exceed twice the specified limits (e.g., for Base-Emitter Voltage Differential 1: 10mV max or 4mV max).
- 3. For AC characteristics read and record measurements shall be performed on a sample of 32 components with 0 failures allowed. Alternatively a 100% inspection may be performed.

### 2.4.2 <u>High and Low Temperatures Electrical Measurements</u>

| Characteristics Symbols           | 3           | MIL-STD-750 |   | Limits |    | Units |
|-----------------------------------|-------------|-------------|---|--------|----|-------|
|                                   | Test Method | Note 1      | Min   | Max    |    |       |
| Collector-Base<br>Cut-off Current | ГСВО        | 3036        | T <sub>amb</sub> =+150(+0-5)°C<br>V <sub>CB</sub> =45V, Bias<br>Condition D |        | 10 | μА    |



| Characteristics                                   | Symbols  | MIL-STD-750 | Test Conditions   | Limits   |       | Units |
|---|--|-------------|---|----------|-------|-------|
|   | Test Method Note 1   |             | Note 1  | Min      | Max   |       |
| Forward-Current<br>Transfer Ratio                 | h <sub>FE1</sub>   | 3076        | T <sub>amb</sub> =-55(+5-0) <sup>o</sup> C<br>V <sub>CE</sub> =5V, I <sub>C</sub> =10μA<br>Variants 04, 07, 10, 13<br>Variants 02, 03, 05, 06, 08, 09, 11, 12, 14, 15   | 20<br>50 | , l+1 |       |
| Forward-Current<br>Transfer Ratio<br>Comparison   | h <sub>FE2-1</sub> /<br>h <sub>FE2-2</sub>                                     | 3076        | $T_{amb}$ =-55 to +125°C $V_{CE}$ =5V, $I_{C}$ =100 $\mu$ A   | 0.85     | 1.18  |       |
| Base-Emitter<br>Voltage<br>Differential<br>Change | IΔ(V <sub>BE1</sub> -<br>V <sub>BE2</sub> )ΔT <sub>a</sub><br><sub>mb</sub> I1 | 3066        | $T_{amb}\text{=-}55(+5\text{-}0)^{\circ}\text{C to} \\ +25\pm3^{\circ}\text{C} \\ V_{\text{CE}}\text{=-}5\text{V} \\ I_{\text{C}}\text{=-}100\mu\text{A} \\ \text{Test condition B} \\ \text{Variants 02, 04, 05, 07, 08, 10, 11, 13, 14} \\ \text{Variants 03, 06, 09, 12, 15} \\$ | -        | 0.8   | mV    |
|   | IΔ(V <sub>BE1</sub> -<br>V <sub>BE2</sub> )ΔT <sub>a</sub><br><sub>mb</sub> I2 | 3066        | $\begin{split} T_{amb} = +25 \pm 3^{\circ} C \text{ to} \\ +125 (+0 -5)^{\circ} C \\ V_{CE} = 5 V \\ I_{C} = 100 \mu A \\ Test \ condition \ B \\ Variants \ 02, \ 04, \ 05, \ 07, \\ 08, \ 10, \ 11, \ 13, \ 14 \\ Variants \ 03, \ 06, \ 09, \ 12, \\ \end{split}$                |          | 1     | mV    |
|   |  |             | 15  | -        | 0.5   |       |

### NOTES:

#### 2.5 PARAMETER DRIFT VALUES

Unless otherwise specified, the measurements shall be performed at  $T_{amb}$ =+22  $\pm 3^{\circ}$ C.

The test methods and test conditions shall be as per the corresponding test defined in Room Temperature Electrical Measurements.

The drift values ( $\Delta$ ) shall not be exceeded for each characteristic specified. The corresponding absolute limit values for each characteristic shall not be exceeded.

Read and record measurements shall be performed on a sample of 5 components with 0 failures allowed. Alternatively a 100% inspection may be performed.



| Characteristics   | Symbols   | Lin                              | Units        |    |
|---|---|----------------------------------|--------------|----|
|   |   | Min                              | Max          |    |
| Collector-Base Cut-off Current  | СВО   | -                                | 2            | nA |
| Collector-Emitter Saturation Voltage  | V <sub>CE(sat)</sub>  |                                  | 350          | mV |
| Forward-Current Transfer Ratio 2<br>Variants 04, 07, 10, 13<br>Variants 02, 03, 05, 06, 08, 09, 11, 12, 14, 15, 16, 17                          | h <sub>FE2</sub>  | 100<br>225                       |              |    |
| Forward-Current Transfer Ratio<br>Comparison  | h <sub>FE2-1</sub> /<br>h <sub>FE2-2</sub>                      | 0.85                             | 1.18         | -  |
| Base-Emitter Voltage Differential 2<br>Variants 02, 04, 05, 07, 08, 10, 11, 13,<br>14<br>Variants 03, 06, 09, 12, 15, 16, 17                    | IV <sub>BE1</sub> -V <sub>BE2</sub> I2                          |                                  | 3<br>1.5     | mV |
| Base-Emitter Voltage Differential<br>Change 1 (Note 1)<br>Variants 02, 04, 05, 07, 08, 10, 11, 13,<br>14<br>Variants 03, 06, 09, 12, 15, 16, 17 | I∆(V <sub>BE1</sub> -<br>V <sub>BE2</sub> )∆T <sub>amb</sub> I1 |                                  | 0.96<br>0.48 | mV |
| Base-Emitter Voltage Differential<br>Change 2 (Note 1)<br>Variants 02, 04, 05, 07, 08, 10, 11, 13, 14<br>Variants 03, 06, 09, 12, 15, 16, 17    | i∆(V <sub>BE1</sub> -<br>V <sub>BE2</sub> )∆T <sub>amb</sub> i2 | relición<br>relición<br>relición | 1.2<br>0.6   | mV |

To be measured after Operating Life test only.

#### 2.7 POWER BURN-IN CONDITIONS

| Characteristics                   | Symbols           | Test Conditions   | Units |
|-----------------------------------|-------------------|---|-------|
| Ambient Temperature               | T <sub>amb</sub>  | +25 to +50  | °C    |
| Power Dissipation (Both Sections) | P <sub>totB</sub> | As per Maximum Ratings.  Derate P <sub>totB1</sub> at the chosen  T <sub>amb</sub> using the specified R <sub>th(j-a)</sub> . | W .   |
| Collector-Base Voltage            | . V <sub>CB</sub> | 40  | V     |

### 2.8

OPERATING LIFE CONDITIONS

The conditions shall be as specified for Power Burn-in.



ISSUE 3

| Characteristics   | Symbols              |                         | Units    |     |    |
|---|----------------------|-------------------------|----------|-----|----|
|   |                      | Drift                   | Absolute |     |    |
|   |                      | Value<br>∆              | Min      | Max |    |
| Collector-Base Cut-off Current  | ГСВО                 | ±0.5<br>or (1)<br>±100% | *        | 2   | nA |
| Collector-Emitter Saturation Voltage  | V <sub>CE(sat)</sub> | ±15<br>or (1)<br>±10%   |          | 350 | mV |
| Forward-Current Transfer Ratio 2<br>Variants 04, 07, 10, 13<br>Variants 02, 03, 05, 06, 08, 09, 11, | h <sub>FE2</sub>     | ±15%                    | 100      | -   |    |
| 12, 14, 15, 16, 17  |                      |                         | 225      | æ   |    |

### NOTES:

### 2.6 INTERMEDIATE AND END-POINT ELECTRICAL MEASUREMENTS

Unless otherwise specified, the measurements shall be performed at T<sub>amb</sub>=+22 ±3°C.

The test methods and test conditions shall be as per the corresponding test defined in either Room Temperature Electrical Measurements or High and Low Temperatures Electrical Measurements, as applicable.

The limit values for each characteristic shall not be exceeded.

<sup>1.</sup> Whichever is greater, referred to the initial value.





## APPENDIX 'A'

# AGREED DEVIATIONS FOR STMICROELECTRONICS (F)

| ITEMS AFFECTED   | DESCRIPTION OF DEVIATIONS  |
|--|--|
| Deviations from<br>Production Control -<br>Chart F2                        | Special In-Process Controls - Internal Visual Inspection. For CCP packages the criteria specified for voids in the fillet and minimum die mounting material around the visible die perimeter for die mounting defects may be omitted providing that a radiographic inspection to verify the die-attach process is performed on a sample basis in accordance with STMicroelectronics procedure 0076637. |
| Deviations from Room<br>Temperature Electrical<br>Measurements             | All AC characteristics (Room Temperature Electrical Measurement Note 2) may be considered guaranteed but not tested if successful pilot lot testing has been performed on the wafer lot which includes AC characteristic measurements per the Detail Specification.  A summary of the pilot lot testing shall be provided if required by the Purchase Order.   |
| Deviations from High<br>and Low Temperatures<br>Electrical<br>Measurements | All characteristics specified may be considered guaranteed but not tested if successful pilot lot testing has been performed on the wafer lot which includes characteristic measurements at high and low temperatures per the Detail Specification.  A summary of the pilot lot testing shall be provided if required by the Purchase Order.   |
| Deviations from<br>Screening Tests - Chart<br>F3                           | Solderability is not applicable unless specifically stipulated in the Purchase Order.  |